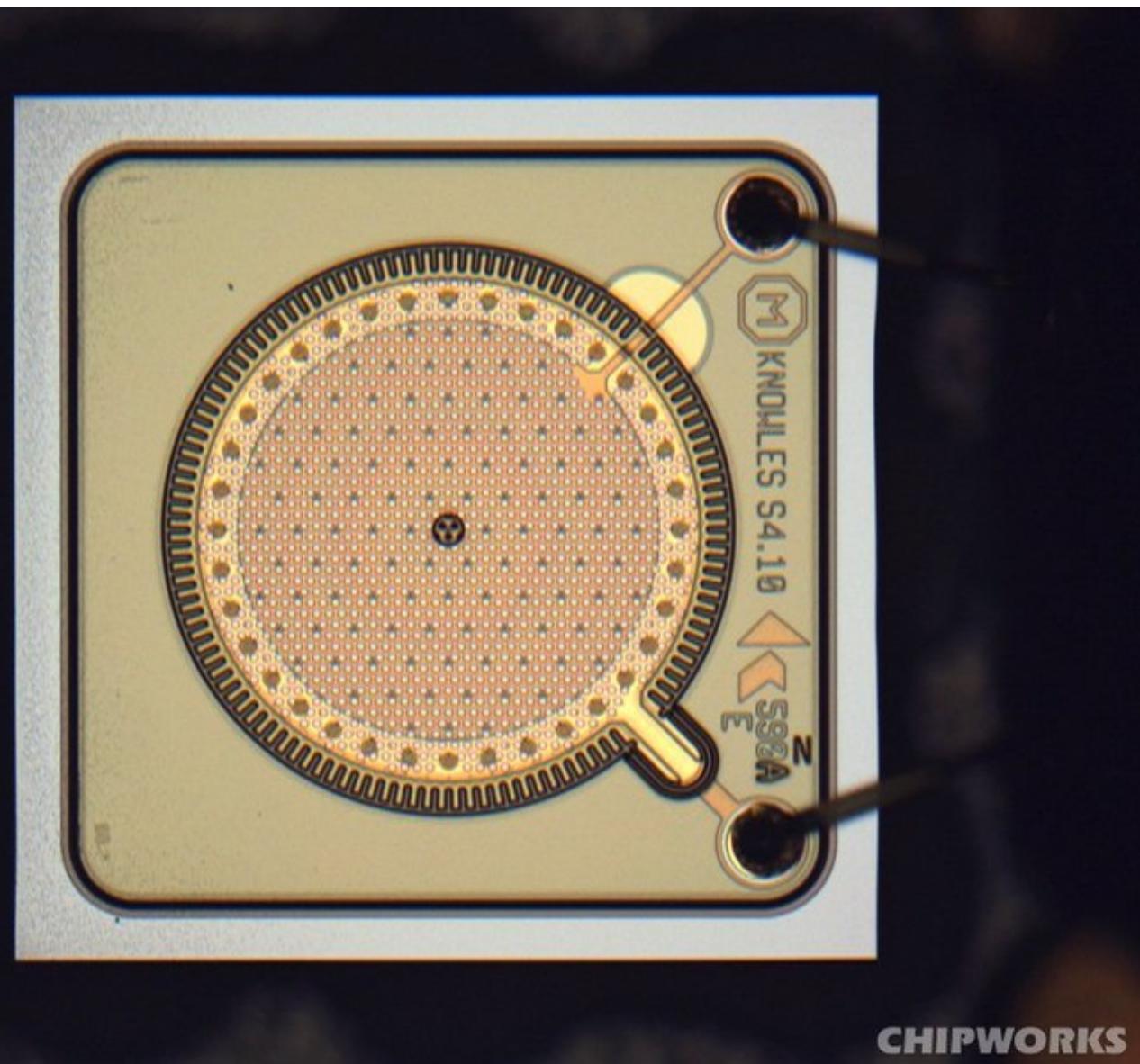




iPhone 4 Microphone Teardown

We explore the innards of the iPhone 4's microphone.

Written By: Miroslav Djuric



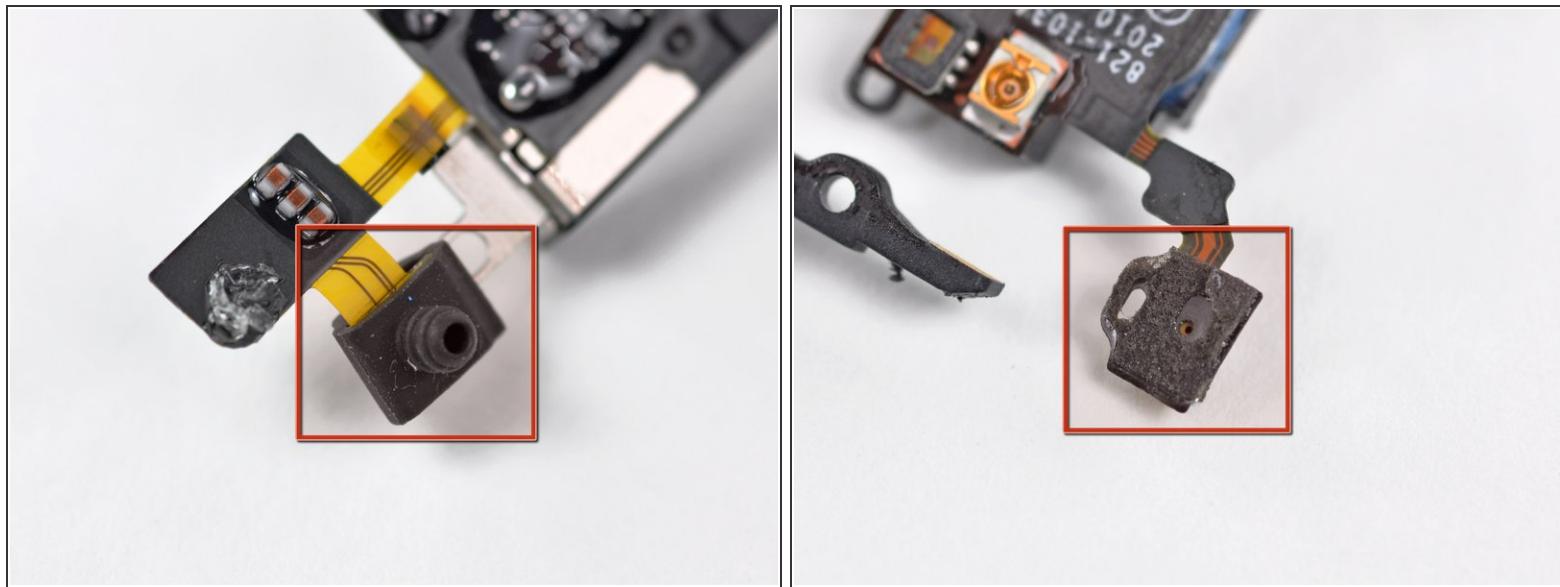
INTRODUCTION

You probably talk more to this device than your significant other. In fact, you probably talk to it the most out of any human or device in the world. It's your phone's microphone, and it's time to take a closer look at this wonderful creation.

We take microphones for granted. The majority of us use them on a daily basis without bothering to recognize their existence. They do so much for us, but we never get to see them or bask in their beauty. Until now.

We've partnered with [Chipworks](#) to reveal to you the multiple microphones contained inside an iPhone 4. There's nothing super-special with these mics -- they're not magical, nor do they contain Steve Jobs' fairy dust -- but they're good representatives of what you can find in today's smartphones.

Step 1 — iPhone 4 Microphone Teardown



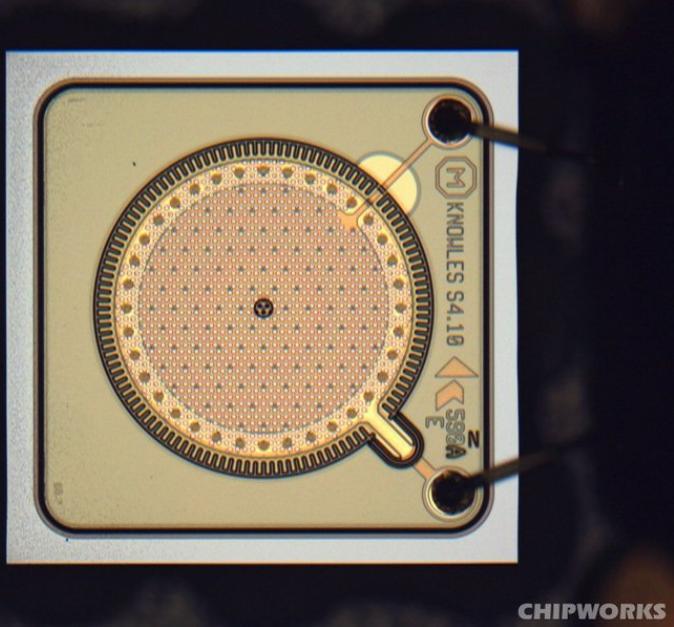
- The iPhone contains three microphones: two in the phone itself, and one in the included Apple earbuds. Given the orientation of the microphones in the device, we assume that one is for making calls and the other intended for capturing video and noise cancellation.
- The iPhone 4 handset has Knowles S1950 and Infineon 1014 microphones (pictured on the left), while the earbuds contain a Knowles S199 mic.

Step 2



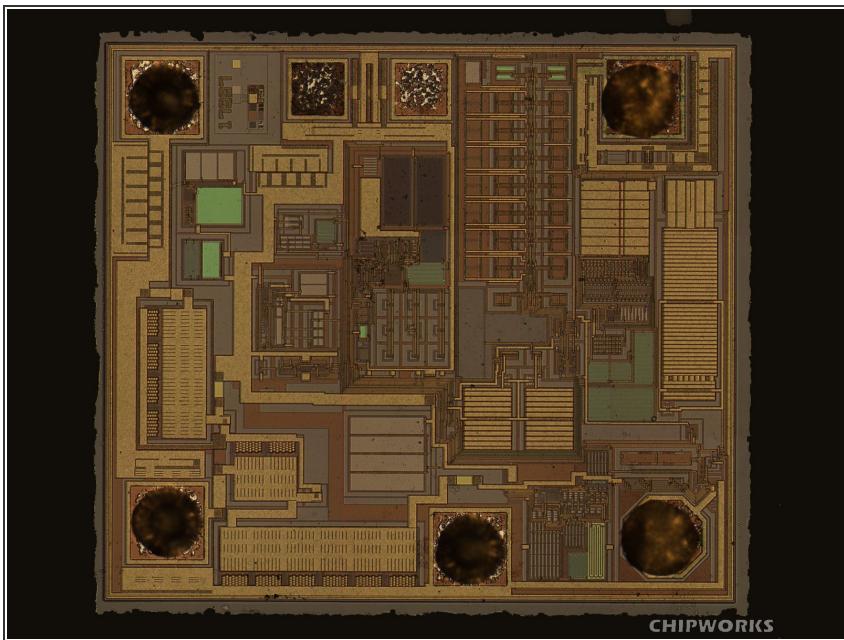
- The first of the two microphones inside the iPhone (the one that you speak into) is the Knowles S1950.
- Knowles describes its [MEMS microphones](#) as being built with a patented CMOS/MEMS technology that allows for very small footprints, lower profiles, and several mounting options.
- Translation: This microphone is very small -- a 3mm x 4mm footprint! And it's [surface-mount](#), which means that a machine just pops it onto the logic board for you.
- From a manufacturing viewpoint, a surface-mount design is valuable because it allows the components to be integrated to the logic board all at once. This eliminates sub-assembly costs, and lowers the [BOM](#) cost. It also allows us to have components on both sides of the board, something that's not possible with [thru-hole](#) technology.

Step 3



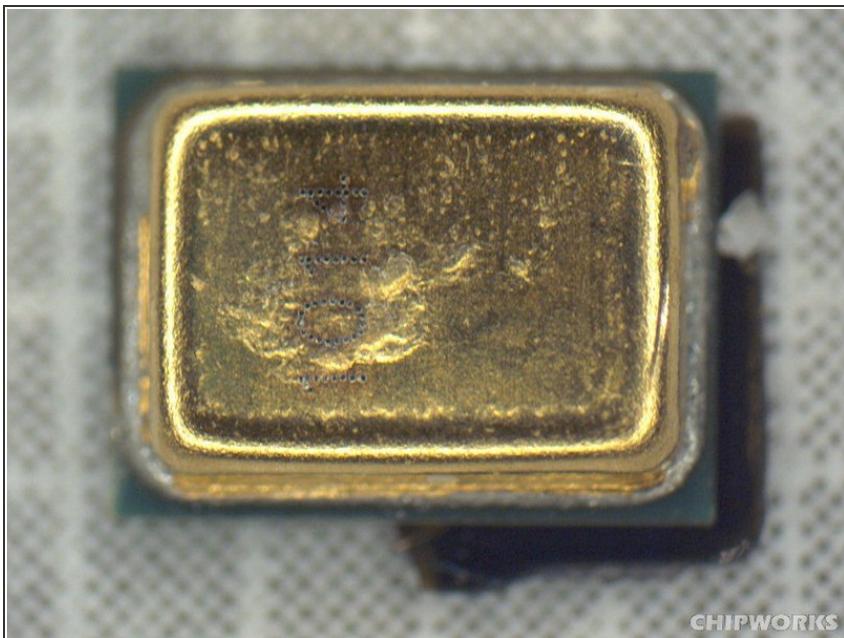
- The Knowles S1950, like the other microphones in the iPhone 4, is comprised of two main parts: the MEMS and the ASIC. You can think of it this way: the MEMS does all the work, and the ASIC does all the thinking. Together, they make an awesome microphone.
- Looking at the S1950 MEMS die gives you an idea of how it functions. Like a microscopic version of a condenser microphone, the microphone itself has a simple design, comprising of two parallel polysilicon plates (very thin plates made of multiple small silicon crystals) that act as plates in a capacitor.
- The upper plate is perforated with an array of small holes, and is separated from the bottom plate by a small air gap. As the sound waves from someone's voice hit this top plate, it deflects very slightly. Because these two plates hold electric charge, these deflections cause minute changes in the electric field between the two plates. The fixed bottom capacitor plate senses and relays these changes as an analog signal.

Step 4



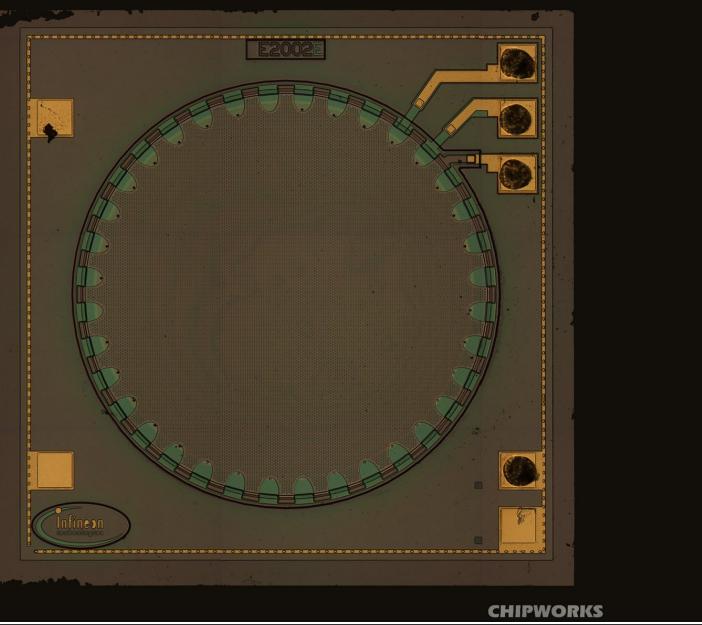
- The S1950 ASIC die interprets the analog signals given off by the MEMS die. This portion of the microphone decodes and processes the analog signal sent to it from the MEMS and sends the result to the iPhone 4's processor.
- Because the microphone has this built-in analog-to-digital converter, the microphone package is very easily integrated with other digital circuitry.

Step 5



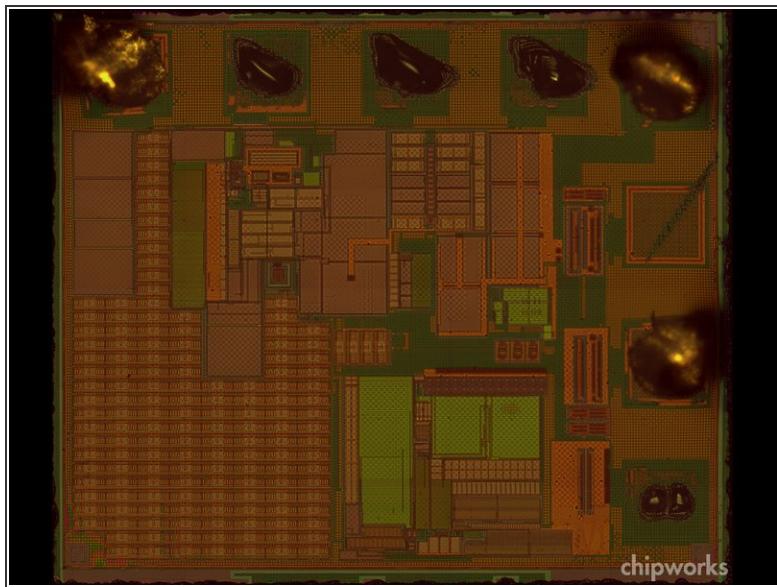
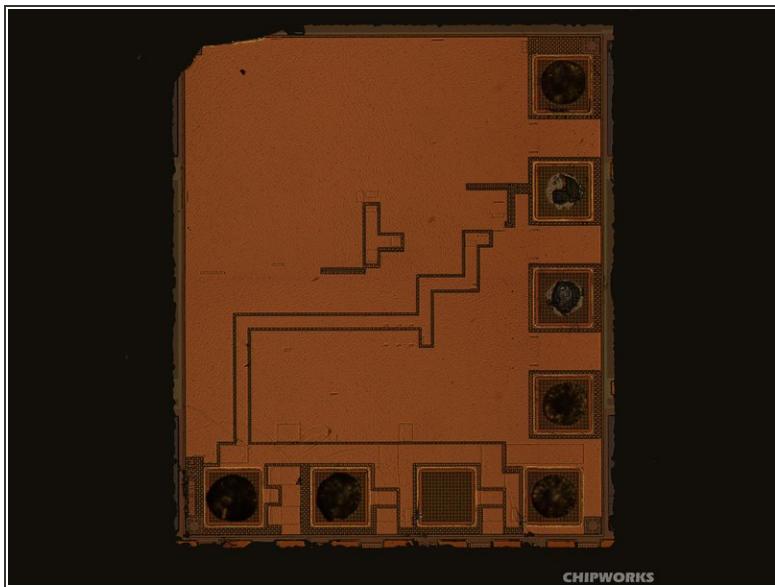
- Infineon manufactures the 1014, the second microphone in the handset. The giant chip maker is a relatively new entrant into the MEMS market, which was dominated by startup companies until about a year ago.
- The industry underwent a lot of change recently, as MEMS devices have gone mass market. Large manufacturers like Infineon have started making MEMS microphones and Akustica (one of the original startups) has been acquired by Bosch.
- The Infineon unit looks quite similar to the Knowles unit externally. Yet, each company works their own magic on the inside.

Step 6



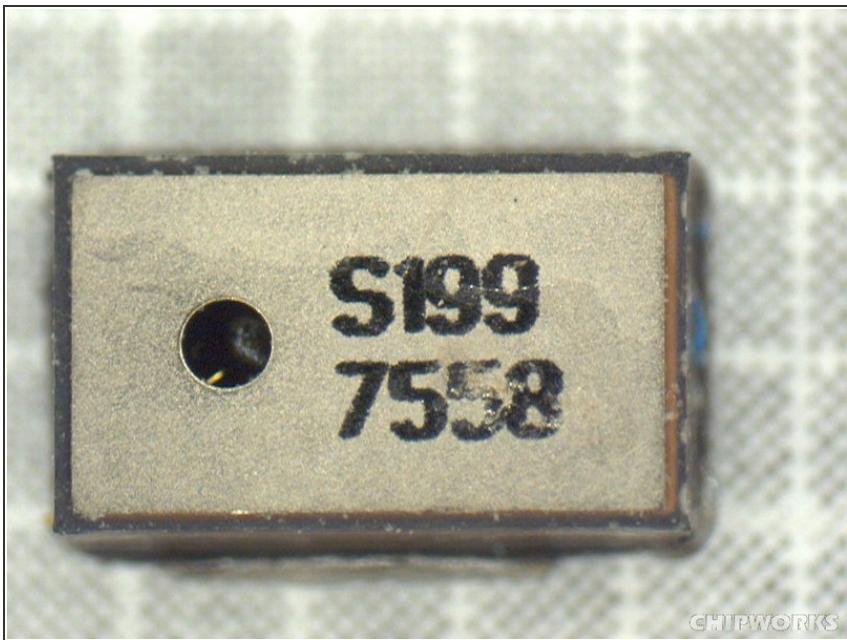
- The Infineon 1014 MEMS die has a similar membrane structure to the Knowles device, with a very nice artistic job done on the die markings -- but they had a lot of space to work with.

Step 7



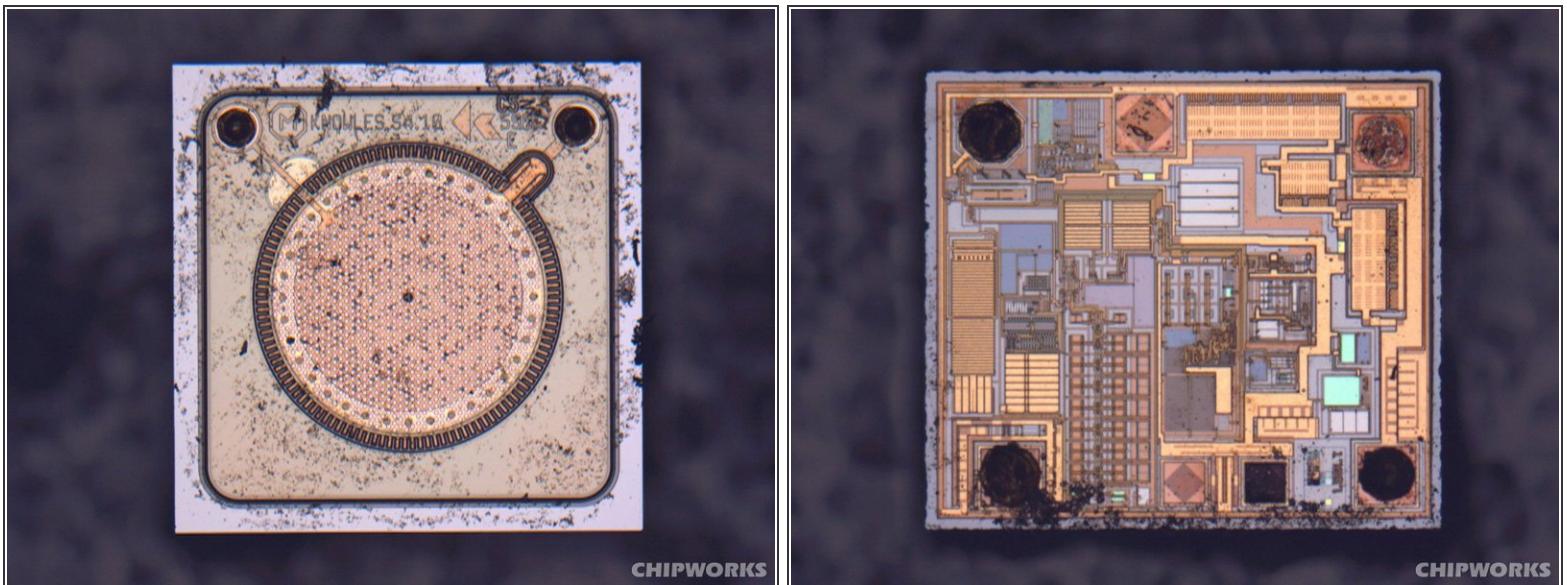
- The die photo for the Infineon 1014 ASIC doesn't reveal too much about its functional layout -- there is a large metal layer over the circuit.
- The metal layer could be acting as a ground plane or might be used RF shielding; or it may simply stop folks from looking at the die circuitry now that teardowns are getting popular.
- But don't worry, we got you ~~uncovered~~ covered. Chipworks had no problem removing the metal layer in order to expose the ASIC die.

Step 8



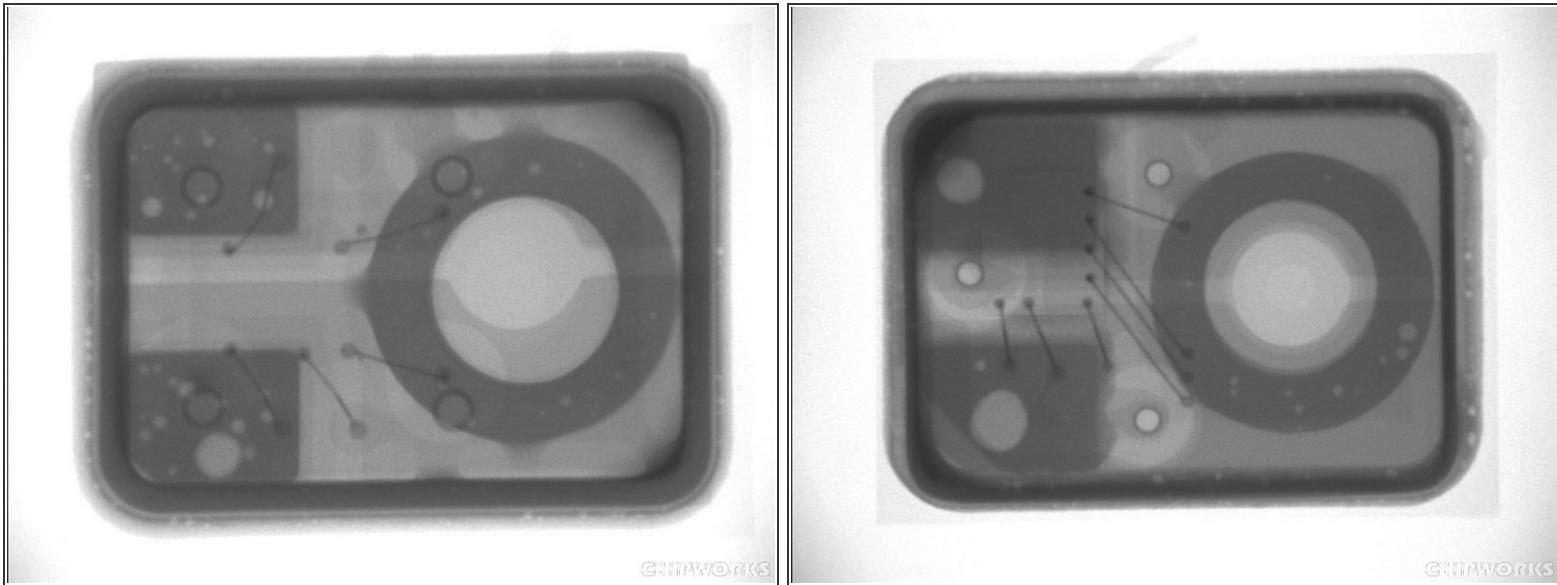
- The second design win for Knowles is the S199 microphone located in the headset that comes with the iPhone 4.
- The physical locations of the microphones are different, so packaging is likely a simple matter of fitting the device to the intended application.

Step 9



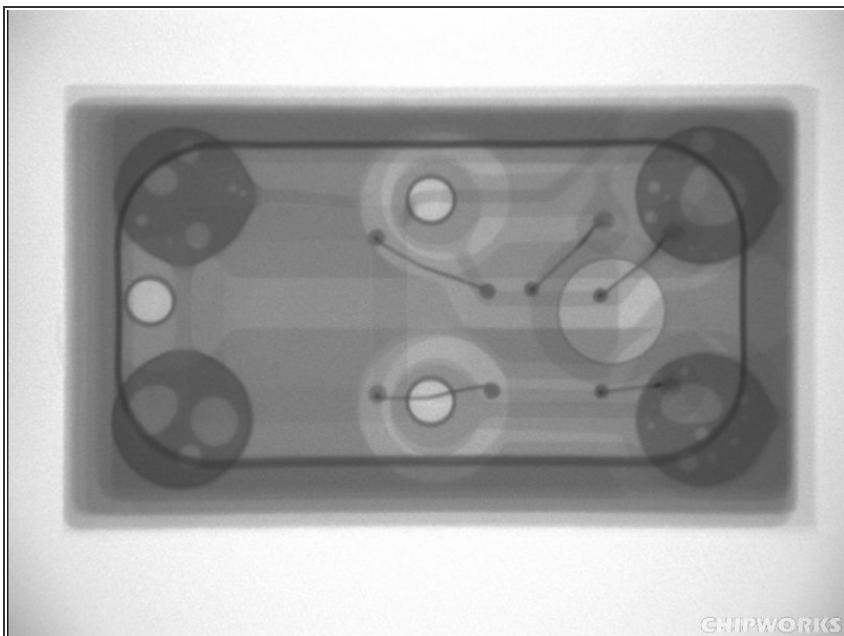
- Note that the two microphones have different package markings but share identical ASIC and MEMS die markings.

Step 10



- X-rays: on the left we have the Knowles 1950, and on the right the Infineon 1014.
- The X-rays really show off the similarity between the Knowles 1950 and the Infineon 1014 units. They're so similar, in fact, that you can easily mistake one for the other if you're not careful.

Step 11



- Here's the Knowles S199 X-ray. It's definitely not as similar as either the Knowles or Infineon units.
- A big thanks to [Chipworks](#) for providing the pictures for this teardown!

To reassemble your device, follow these instructions in reverse order.